



APSEMI

**AC3M0120100K**  
**Silicon Carbide Power MOSFET**  
**N-Channel Enhancement Mode**

## Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating ; RoHS compliant

Parameter	Rating	Units
$V_{DS}$	1000	V
$I_D @ 25^\circ C$	24	A
$R_{DS(on)}$	120	m Ω

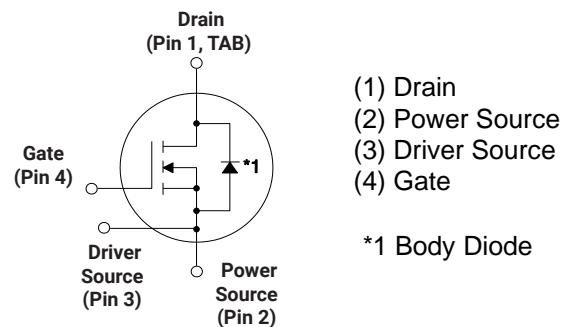


## Applications

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- Induction heating



TO-247-4  
Package



Inner circuit

## Maximum Ratings ( $T_c = 25^\circ C$ unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
$V_{DSmax}$	Drain - Source Voltage	1000	V	$V_{GS} = 0 V, I_D = 100 \mu A$	
$V_{GSmax}$	Gate - Source Voltage (dynamic)	-8/+19	V	AC ( $f > 1 Hz$ )	
$V_{GSop}$	Gate - Source Voltage (static)	-4/+15	V	Static	
$I_D$	Continuous Drain Current	24	A	$V_{GS} = 15 V, T_c = 25^\circ C$	
		16		$V_{GS} = 15 V, T_c = 100^\circ C$	
$I_{D(pulse)}$	Pulsed Drain Current	50	A	Pulse width $t_p$ limited by $T_{jmax}$	
$P_D$	Power Dissipation	92	W	$T_c = 25^\circ C, T_j = 150^\circ C$	
$T_J, T_{stg}$	Operating Junction and Storage Temperature	-55 to +150	°C		
$T_L$	Solder Temperature	260	°C	1.6mm (0.063") from case for 10s	

Note (1): When using MOSFET Body Diode  $V_{GSmax} = -4V/+19V$

Note (2): MOSFET can also safely operate at 0/+15 V



APSEMI

AC3M0120100K

Silicon Carbide Power MOSFET  
N-Channel Enhancement ModeElectrical Characteristics ( $T_c = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions	Note	
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	1000			V	$V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$		
$V_{GS(\text{th})}$	Gate Threshold Voltage	1.8	2.1	3.7	V	$V_{DS} = V_{GS}, I_D = 3 \text{ mA}$		
			1.6		V	$V_{DS} = V_{GS}, I_D = 3 \text{ mA}, T_J = 150^\circ\text{C}$		
$I_{DSS}$	Zero Gate Voltage Drain Current		1	100	$\mu\text{A}$	$V_{DS} = 1000 \text{ V}, V_{GS} = 0 \text{ V}$		
$I_{GSS}$	Gate-Source Leakage Current		10	250	nA	$V_{GS} = 15 \text{ V}, V_{DS} = 0 \text{ V}$		
$R_{DS(on)}$	Drain-Source On-State Resistance		120	155	$\text{m}\Omega$	$V_{GS} = 15 \text{ V}, I_D = 15 \text{ A}$		
			175			$V_{GS} = 15 \text{ V}, I_D = 15 \text{ A}, T_J = 150^\circ\text{C}$		
$g_{fs}$	Transconductance		9.2		S	$V_{DS} = 20 \text{ V}, I_{DS} = 15 \text{ A}$		
			7.1			$V_{DS} = 20 \text{ V}, I_{DS} = 15 \text{ A}, T_J = 150^\circ\text{C}$		
$C_{iss}$	Input Capacitance		366		pF	$V_{GS} = 0 \text{ V}, V_{DS} = 700 \text{ V}$ $f = 1 \text{ MHz}$ $V_{AC} = 25 \text{ mV}$		
$C_{oss}$	Output Capacitance		48					
$C_{rss}$	Reverse Transfer Capacitance		3					
$E_{oss}$	$C_{oss}$ Stored Energy		12.2		$\mu\text{J}$	$V_{DS} = 700 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_D = 15 \text{ A}, R_{G(\text{ext})} = 2.5 \Omega, L = 158 \mu\text{H}, T_J = 150^\circ\text{C}$		
$E_{ON}$	Turn-On Switching Energy (Body Diode FWD)		120		$\mu\text{J}$			
$E_{OFF}$	Turn Off Switching Energy (Body Diode FWD)		22					
$t_{d(on)}$	Turn-On Delay Time		5		$V_{DD} = 700 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 15 \text{ A}, R_{G(\text{ext})} = 2.5 \Omega,$ Timing relative to $V_{DS}$ Inductive load			
$t_r$	Rise Time		9					
$t_{d(off)}$	Turn-Off Delay Time		14			$ns$		
$t_f$	Fall Time		7					
$R_{G(int)}$	Internal Gate Resistance		13					
$Q_{gs}$	Gate to Source Charge		5		$n\text{C}$	$V_{DS} = 700 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 15 \text{ A}$ Per IEC60747-8-4 pg 21		
$Q_{gd}$	Gate to Drain Charge		10					
$Q_g$	Total Gate Charge		20					

Reverse Diode Characteristics ( $T_c = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
$V_{SD}$	Diode Forward Voltage	4.8		V	$V_{GS} = -4 \text{ V}, I_{SD} = 7.5 \text{ A}$	
		4.4		V	$V_{GS} = -4 \text{ V}, I_{SD} = 7.5 \text{ A}, T_J = 150^\circ\text{C}$	
$I_S$	Continuous Diode Forward Current		15	A	$V_{GS} = -4 \text{ V}$	
$I_{S,pulse}$	Diode pulse Current		50	A	$V_{GS} = -4 \text{ V}$ , pulse width $t_p$ limited by $T_{jmax}$	
$t_{rr}$	Reverse Recover time	20		ns	$V_{GS} = -4 \text{ V}, I_{SD} = 15 \text{ A}, V_R = 700 \text{ V}$ $dif/dt = 2400 \text{ A}/\mu\text{s}, T_J = 150^\circ\text{C}$	
$Q_{rr}$	Reverse Recovery Charge	193		nC		
$I_{rrm}$	Peak Reverse Recovery Current	18		A		

## Thermal Characteristics

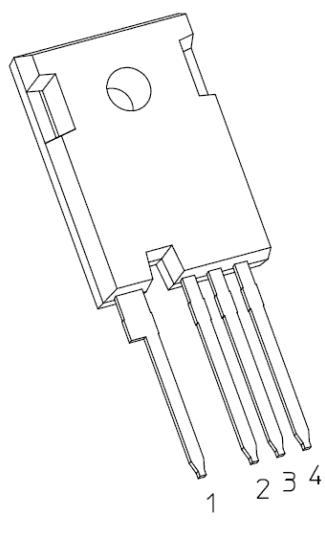
Symbol	Parameter	Max.	Unit	Test Conditions	Note
$R_{qJC}$	Thermal Resistance from Junction to Case	1.5	$^\circ\text{C}/\text{W}$		
$R_{qJA}$	Thermal Resistance From Junction to Ambient	40			



APSEMI

AC3M0120100K  
Silicon Carbide Power MOSFET  
N-Channel Enhancement Mode

Package Dimensions



TO-247-4

